

### **STS4NF100**

N-channel 100V - 0.065Ω - 4A SO-8 STripFET™ II Power MOSFET

#### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STS4NF100	100V	<0.070Ω	4A

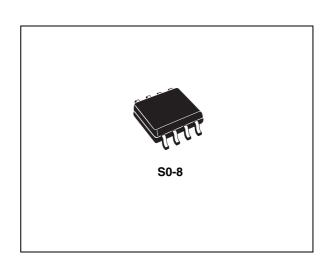
- Exceptional dv/dt capability
- 100 % avalanche tested
- Application oriented characterization

#### **Description**

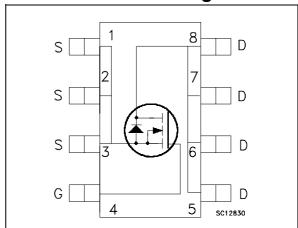
This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements.

### **Applications**

Switching application



### Internal schematic diagram



#### **Order codes**

Part number	t number Marking Package		Packaging
STS4NF100	S4NF100	SO-8	Tape & reel

Contents STS4NF100

## **Contents**

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STS4NF100 Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (v <sub>gs</sub> = 0)	100	V
V <sub>GS</sub>	Gate- source voltage	±20	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	4	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	2.5	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	16	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	2.5	W

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Thermal data

R <sub>thj-a</sub>	Thermal resistance junction-ambient Max single operation <sup>(1)</sup>	50	°C/W
$T_J$	Thermal operating junction-ambient	-55 to 150	°C
T <sub>stg</sub>	Storage temperature	-55 to 150	°C

<sup>1.</sup> Mounted on FR-4 board (t 10 sec.).

Electrical characteristics STS4NF100

### 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Parameter Test conditions		Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source Breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	100			V
I <sub>DSS</sub>	Zero gate voltage Drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ =Max rating, $T_{C}$ =125°C			1 10	µА µА
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V, I_D = 2A$		0.065	0.070	W

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	$V_{DS} > I_{D(on)}xR_{DS(on)max}$ $I_{D}= 2 A$		10		S
C <sub>iss</sub>	Input capacitance			870		pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, $ $V_{GS} = 0$		125		pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$		52		pF
Qg	Total gate charge			30	41	nC
$Q_{gs}$	Gate-source charge	$V_{DD} = 80V, I_D = 4A,$ $V_{GS} = 10V$		6		nC
$Q_{gd}$	Gate-drain charge	·GS = 101		10		nC

<sup>1.</sup> Pulsed: Pulse duration =  $300 \mu s$ , duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time Rise time	$V_{DD}$ =50 V, $I_{D}$ =4A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ = 10V (see Figure 12)		58 45		ns ns
t <sub>d(off)</sub>	Turn-off Delay Time Fall Time	$V_{DD} = 50 \text{ V}, I_D = 4 \text{ A}$ $R_G = 4.7 \Omega$ $V_{GS} = 10 \text{ V}$ (see Figure 12)		49 17		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				4	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				16	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 4A, V_{GS} = 0$			1.2	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 4A, V_{DD} = 30V$ di/dt = 100A/ $\mu$ s, $T_j = 150$ °C (see Figure 14)		100 375 7.5		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5 %

Electrical characteristics STS4NF100

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

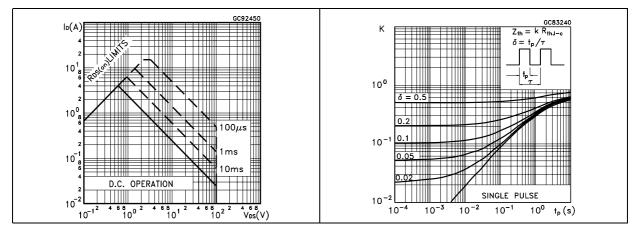


Figure 3. Output characterisics

Figure 4. Transfer characteristics

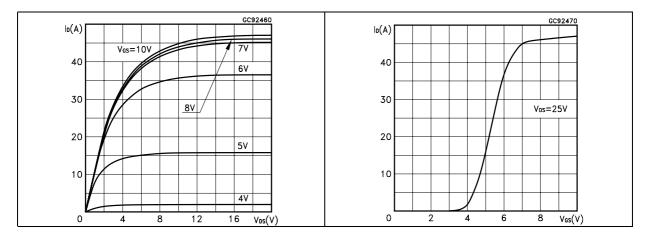


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

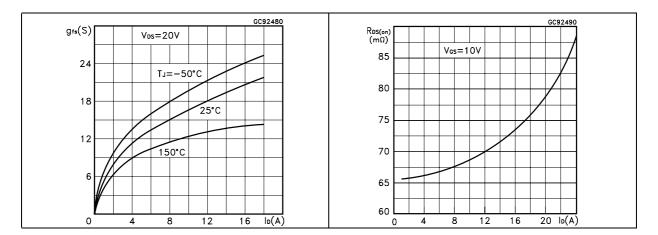


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

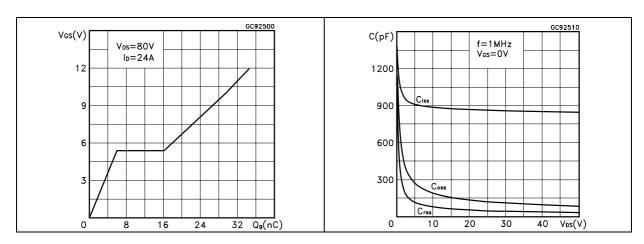


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

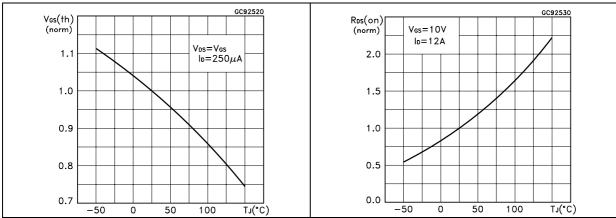
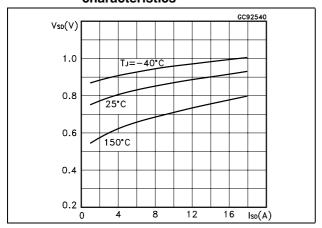


Figure 11. Source-drain diode forward characteristics



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Test circuit STS4NF100

### 3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

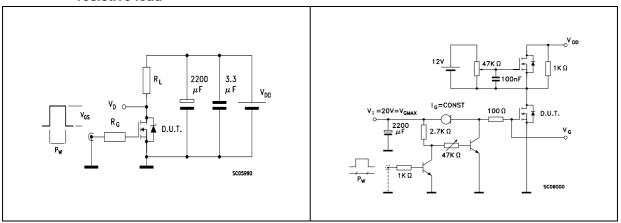


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

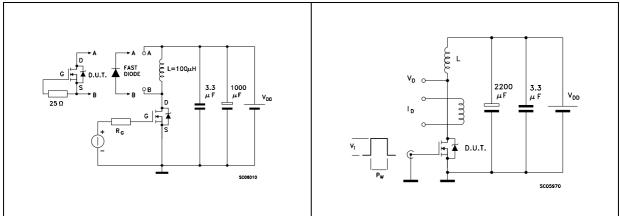
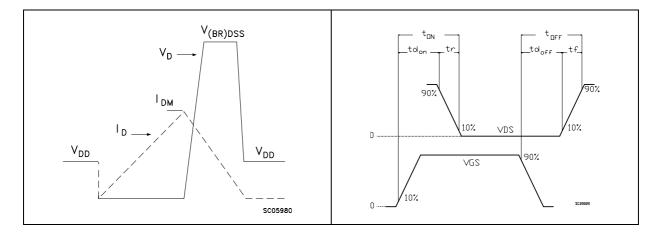


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform

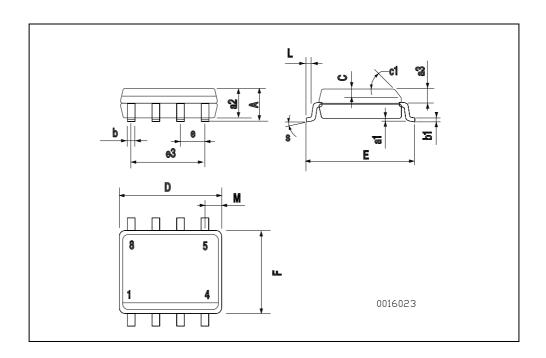


### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

#### **SO-8 MECHANICAL DATA**

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45 (	(typ.)		•
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S		•	8 (n	nax.)	•	•



STS4NF100 Revision history

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
11-Sep-2006	1	First release
15-Nov-2006	2	The document has been reformatted
26-Jan-2007	3	Typo mistake on Table 2.

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